

Electronic Acknowledgement Receipt

EFS ID:	5132241
Application Number:	10755042
International Application Number:	
Confirmation Number:	8665
Title of Invention:	Integrated chip package structure using silicon substrate and method of manufacturing the same
First Named Inventor/Applicant Name:	Mou-Shiung Lin
Customer Number:	27765
Filer:	Winston Hsu
Filer Authorized By:	
Attorney Docket Number:	MEGP0004USA1
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Application Type:	Utility under 35 USC 111(a)

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Payment was successfully received in RAM	\$ 940
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Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Request for Continued Examination (RCE)	MEGP0004-1-R1-4-SB30e.pdf	768829	no	3
			2ee6d6ede3a55e494d2cfae3ce1f5742a3508c31		
Warnings:					
Information:					
2	Extension of Time	MEGP0004-1-A2-11-SB22.pdf	66248	no	1
			0a26b122d2517993b0484104821568af6291c2bf		
Warnings:					
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3	Amendment Submitted/Entered with Filing of CPA/RCE	MEGP0004USA1_R1_4_AM.pdf	153398	no	1
			0e65af2c07ba63e9402aa6549a03f0a8c2a5e802		
Warnings:					
Information:					
4	Claims	MEGP0004USA1_R1_4_CLAM.pdf	250239	no	7
			8c00812140c61a7e2803c3002ffd5223a47a2118		
Warnings:					
Information:					
5	Applicant Arguments/Remarks Made in an Amendment	MEGP0004USA1_R1_4_RM.pdf	249910	no	13
			d0d33b6b642fa8f3c5466b1a5cc8ae891f79e65c		
Warnings:					
Information:					
6	Fee Worksheet (PTO-06)	fee-info.pdf	32122	no	2
			162bd9906c0b348785baade2bc5b299ed2829752		
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National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

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